Plastic Darlington Complementary Silicon Power Transistors

These devices are designed for general-purpose amplifier and low-speed switching applications.

Features

• High DC Current Gain – $h_{FE} = 2000 \text{ (Typ)} @ I_C$

$$= 2.0 \text{ Adc}$$

- Monolithic Construction with Built-in Base-Emitter Resistors to Limit Leakage Multiplication
- Choice of Packages MJE700 and MJE800 Series
- Pb-Free Packages are Available*

MAXIMUM RATINGS

Rating	Symbol	Value	Unit
Collector-Emitter Voltage MJE700, MJE800 MJE702, MJE703, MJE802, MJE803	V _{CEO}	60 80	Vdc
Collector-Base Voltage MJE700, MJE800 MJE702, MJE703, MJE802, MJE803	V _{CB}	60 80	Vdc
Emitter-Base Voltage	V _{EB}	5.0	Vdc
Collector Current	۱ _C	4.0	Adc
Base Current	Ι _Β	0.1	Adc
Total Power Dissipation @ $T_C = 25^{\circ}C$ Derate above $25^{\circ}C$	P _D	40 0.32	W mW/°C
Operating and Storage Junction Temperature Range	T _J , T _{stg}	-55 to +150	°C

THERMAL CHARACTERISTICS

Characteristic	Symbol	Max	Unit
Thermal Resistance, Junction-to-Case	θ_{JC}	6.25	°C/W

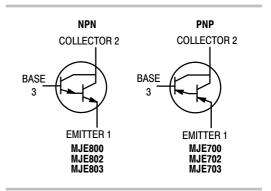
Stresses exceeding Maximum Ratings may damage the device. Maximum Ratings are stress ratings only. Functional operation above the Recommended Operating Conditions is not implied. Extended exposure to stresses above the Recommended Operating Conditions may affect device reliability.



ON Semiconductor®

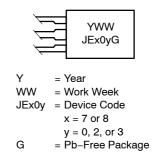
http://onsemi.com

4.0 AMPERE DARLINGTON POWER TRANSISTORS COMPLEMENTARY SILICON 40 WATT 50 WATT





MARKING DIAGRAM



*For additional information on our Pb–Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

ORDERING INFORMATION See detailed ordering and shipping information in the package

dimensions section on page 5 of this data sheet.

Semiconductor Components Industries, LLC, 2011
May, 2011 – Rev. 11

ELECTRICAL CHARACTERISTICS (T_C = 25°C unless otherwise noted)

Characteristic	Symbol	Min	Max	Unit
DFF CHARACTERISTICS				
Collector-Emitter Breakdown Voltage (Note 1) MJE700, MJE800 (I _C = 50 mAdc, I _B = 0) MJE702, MJE703, MJE802, MJE803	V _{(BR)CEO}	60 80		Vdc
Collector Cutoff Current MJE700, MJE800 (V _{CE} = 60 Vdc, I _B = 0) MJE702, MJE703, MJE802, MJE803 (V _{CE} = 80 Vdc, I _B = 0) MJE702, MJE703, MJE802, MJE803	I _{CEO}		100 100	μAdc
Collector Cutoff Current (V_{CB} = Rated BV _{CEO} , I _E = 0) (V_{CB} = Rated BV _{CEO} , I _E = 0, T _C = 100°C)	I _{CBO}		100 500	μAdc
Emitter Cutoff Current ($V_{BE} = 5.0 \text{ Vdc}, I_C = 0$)	I _{EBO}	_	2.0	mAdc

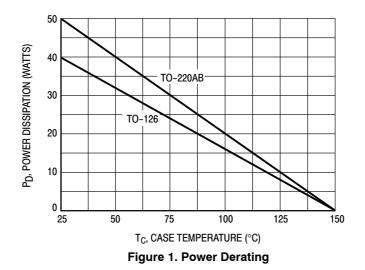
ON CHARACTERISTICS

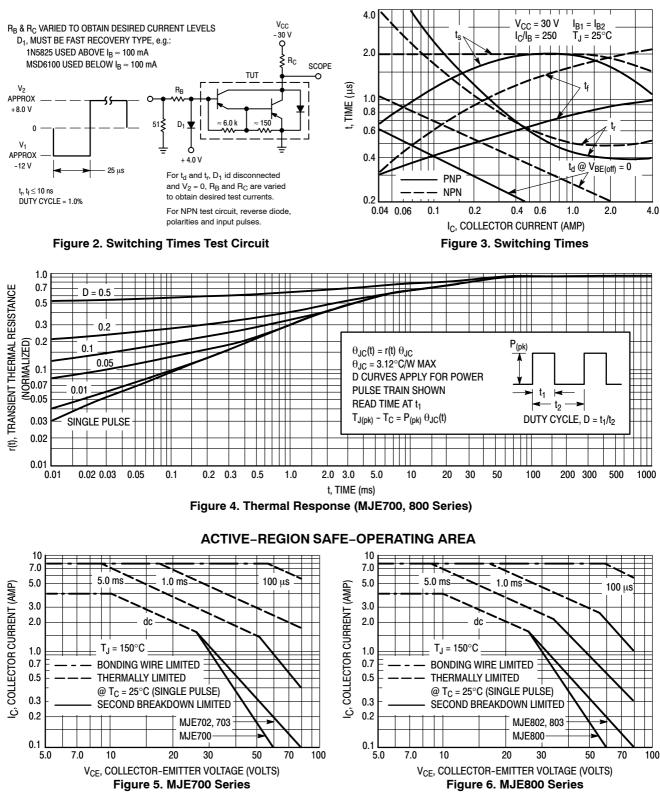
$\begin{array}{l} \text{DC Current Gain (Note 1)} \\ (I_{C} = 1.5 \; \text{Adc}, \; V_{CE} = 3.0 \; \text{Vdc}) \\ (I_{C} = 2.0 \; \text{Adc}, \; V_{CE} = 3.0 \; \text{Vdc}) \\ (I_{C} = 4.0 \; \text{Adc}, \; V_{CE} = 3.0 \; \text{Vdc}) \end{array}$	MJE700, MJE702, MJE800, MJE802 MJE703, MJE803 All devices	h _{FE}	750 750 100	- - -	-
$\begin{array}{l} \mbox{Collector-Emitter Saturation Voltage (Note} \\ (I_C = 1.5 \mbox{ Adc}, I_B = 30 \mbox{ mAdc}) \\ (I_C = 2.0 \mbox{ Adc}, I_B = 40 \mbox{ mAdc}) \\ (I_C = 4.0 \mbox{ Adc}, I_B = 40 \mbox{ mAdc}) \end{array}$	1) MJE700, MJE702, MJE800, MJE802 MJE703, MJE803 All devices	V _{CE(sat)}		2.5 2.8 3.0	Vdc
$\begin{array}{l} \text{Base-Emitter On Voltage (Note 1)} \\ (I_{C} = 1.5 \; \text{Adc}, \; V_{CE} = 3.0 \; \text{Vdc}) \\ (I_{C} = 2.0 \; \text{Adc}, \; V_{CE} = 3.0 \; \text{Vdc}) \\ (I_{C} = 4.0 \; \text{Adc}, \; V_{CE} = 3.0 \; \text{Vdc}) \end{array}$	MJE700, MJE702, MJE800, MJE802 MJE703, MJE803 All devices	V _{BE(on)}	- - -	2.5 2.5 3.0	Vdc

DYNAMIC CHARACTERISTICS

Small–Signal Current Gain (I _C = 1.5 Adc, V _{CE} = 3.0 Vdc, f = 1.0 MHz)	h _{fe}	1.0	-	-	Ī
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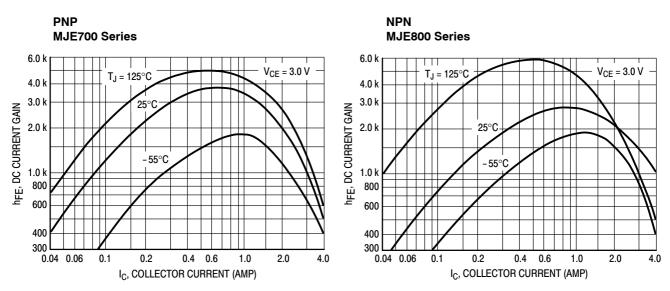
1. Pulse Test: Pulse Width \leq 300 μ s, Duty Cycle \leq 2.0%.



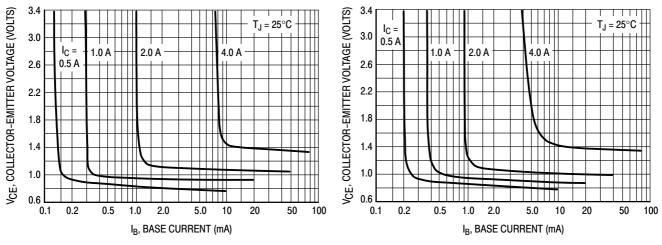


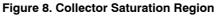
There are two limitations on the power handling ability of a transistor: average junction temperature and second breakdown. Safe operating area curves indicate I_C – V_{CE} limits of the transistor that must be observed for reliable operation; i.e., the transistor must not be subjected to greater dissipation than the curves indicate.

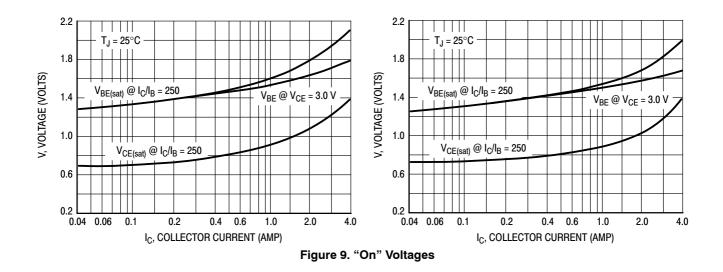
The data of Figures 5 and 6 are based on $T_{J(pk)} = 150^{\circ}$ C; T_{C} is variable depending on conditions. Second breakdown pulse limits are valid for duty cycles to 10% provided $T_{J(pk)} < 150^{\circ}$ C. $T_{J(pk)}$ may be calculated from the data in Figure 4. At high case temperatures, thermal limitations will reduce the power that can be handled to values less than the limitations imposed by second breakdown.









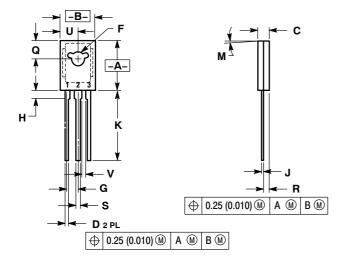


ORDERING INFORMATION

Device	Package	Shipping
MJE700	TO-225	
MJE700G	TO-225 (Pb-Free)	
MJE702	TO-225	
MJE702G	TO-225 (Pb-Free)	
MJE703	TO-225	
MJE703G	TO-225 (Pb-Free)	
MJE800	TO-225	50 Units / Bulk
MJE800G	TO-225 (Pb-Free)	
MJE802	TO-225	
MJE802G	TO-225 (Pb-Free)	
MJE803	TO-225	
MJE803G	TO-225 (Pb-Free)	

PACKAGE DIMENSIONS

TO-225 CASE 77-09 ISSUE Z



NOTES:

1. DIMENSIONING AND TOLERANCING PER ANSI

Y14.5M, 1982. CONTROLLING DIMENSION: INCH.

 CONTROLLING DIMENSION. INCH.
077-01 THRU -08 OBSOLETE, NEW STANDARD 077-09.

	INCHES		MILLIN	IETERS
DIM	MIN	MAX	MIN	MAX
Α	0.425	0.435	10.80	11.04
В	0.295	0.305	7.50	7.74
С	0.095	0.105	2.42	2.66
D	0.020	0.026	0.51	0.66
F	0.115	0.130	2.93	3.30
G	0.094 BSC		2.39 BSC	
Н	0.050	0.095	1.27	2.41
J	0.015	0.025	0.39	0.63
K	0.575	0.655	14.61	16.63
Μ	5° TYP		5° TYP	
Q	0.148	0.158	3.76	4.01
R	0.045	0.065	1.15	1.65
S	0.025	0.035	0.64	0.88
U	0.145	0.155	3.69	3.93
V	0.040		1.02	

STYLE 1: PIN 1. EMITTER 2. COLLECTOR

3. BASE

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